

IR26-61C/L110/TR8

## Technical Data Sheet 1.6mm round Subminiature Side Looking Infrared LED

#### Features

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel.
- Pb free
- The product itself will remain within RoHS compliant version.

#### Descriptions

• IR26-61C/L110/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor

### Applications

• Infrared applied system

#### **Device Selection Guide**

	Chip		
LED Part No.	Material	Lens Color	
IR26-61C/L110/TR8	GaAlAs	Water Clear	

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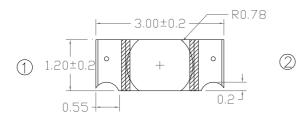
(2)

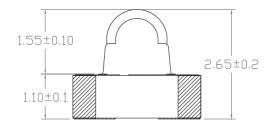
1) Cathode

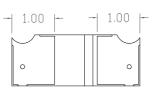
(2) Anode

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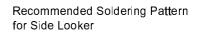
### **Package Dimensions**







(1)



## Notes: 1.All dimensions are in millimeters

2.Tolerances unless dimensions  $\pm 0.1$ mm

### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units	
Continuous Forward Current	$I_{\rm F}$	65	mA	
Reverse Voltage	V <sub>R</sub>	5	V	
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C	
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C	
Soldering Temperature *1	T <sub>sol</sub>	260	°C	
Power Dissipation at(or below)	$P_d$	100	mW	
25°C Free Air Temperature				

**Notes:** \*1:Soldering time  $\leq$  5 seconds.

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Electro-Optical Characteristics (1a=25 C)								
Parameter	Symbol	Condition	Min.	Typ.	Max.	Units		
		I <sub>F</sub> =20mA	1.0	3.0				
Radiant Intensity	Ie	$I_F = 100 mA$ Pulse Width $\leq 100  \mu$ s ,Duty $\leq 1\%$		14		mW/sr		
Peak Wavelength	λp	I <sub>F</sub> =20mA	920	940	960	nm		
Spectral Bandwidth	Δλ	I <sub>F</sub> =20mA		50		nm		
Forward Voltage	$V_{\rm F}$	I <sub>F</sub> =20mA		1.2	1.5	V		
		$I_F = 100 mA$ Pulse Width $\leq 100 \ \mu \text{ s}$ , Duty $\leq 1\%$		1.5	1.8			
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V			10	$\mu A$		
Optical Rise Time	tr	I <sub>F</sub> =20mA		700		ns		
Optical Fall Time	tf	I <sub>F</sub> =20mA		400		ns		
View Angle	2 <del>0</del> 1/2	I <sub>F</sub> =20mA		25		deg		

#### Electro-Optical Characteristics (Ta=25°C)

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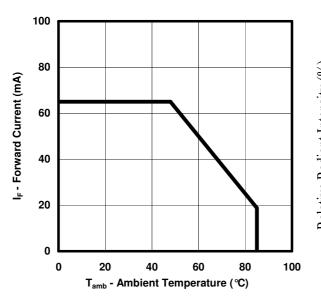
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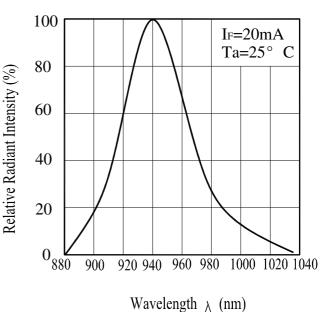
### **Typical Electro-Optical Characteristics Curves**

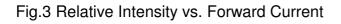
Fig.1 Forward Current vs.

Fig.2 Spectral Distribution

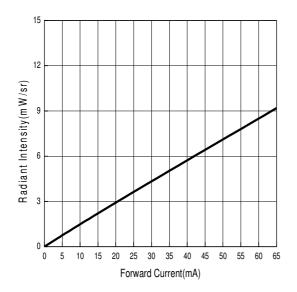
**Ambient Temperature** 



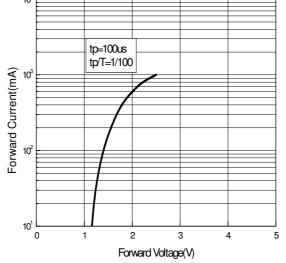








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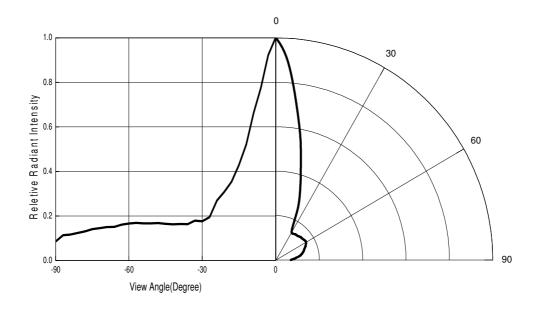
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## **Typical Electro-Optical Characteristics Curves**

Fig.6 Relative Radiant Intensity vs.

Angular Displacement



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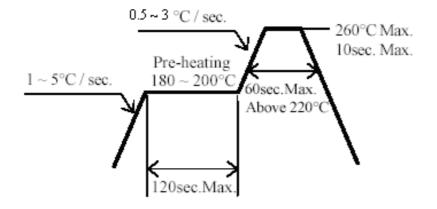
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#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 The LEDs should be used within a year.
  - 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 70%RH or less.
  - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
  - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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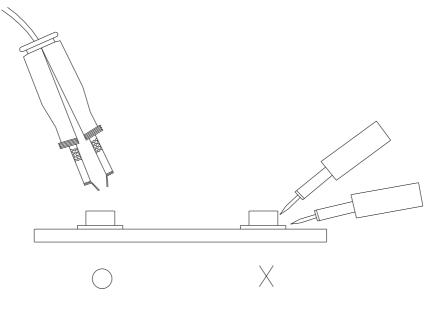
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4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



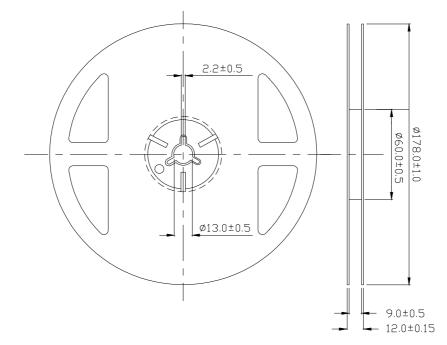
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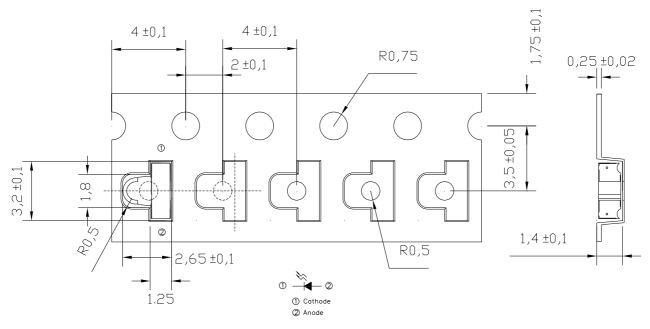
#### **Package Dimensions**

1. Reel Dimensions



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

2. Carrier Tape Dimensions:(Quantity: 1500pcs/reel)



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

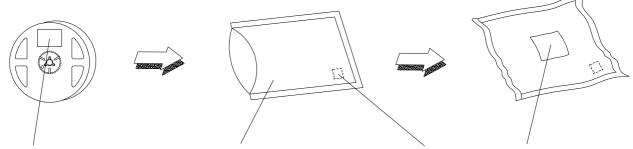
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## IR26-61C/L110/TR8

Label

#### **Packing Procedure**



Label

Aluminum moistue-proof bag

Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number MADE IN TAIWAN: Production Place

Desiccant

#### Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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